



CST20P09L P-Ch 20V Fast Switching MOSFETs

- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

CST20P09L Description

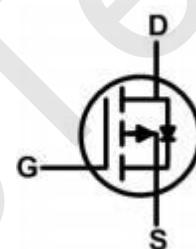
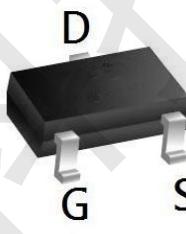
The CST20P09L is the high cell density trenched P-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications. The CST20P09L meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

CST20P09L Product Summary



BVDSS	RDS(ON)	ID
-20V	13mΩ	-9A

CST20P09L SOT23-3L Pin Configuration



CST20P09L Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current	I_D	-9	A
		-4	
Pulsed Drain Current ¹	I_{DM}	-66	A
Single Pulse Avalanche Energy ²	EAS	28.8	mJ
Total Power Dissipation	P_D	30	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

CST20P09L Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ³	$R_{\theta JA}$	41.6	°C/W



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CST20P09L Electrical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-20	-	-	V
Gate-body Leakage current	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 12\text{V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current $T_J = 25^\circ\text{C}$	I_{DSS}	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$	-	-	-1	μA
$T_J = 100^\circ\text{C}$			-	-	-100	
Gate-Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-0.4	-0.65	-1	V
Drain-Source On-Resistance ⁴	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_D = -8\text{A}$	-	13.0	18	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5\text{V}, I_D = -6\text{A}$	-	17	23	
Forward Transconductance ⁴	g_{fs}	$V_{\text{DS}} = -4.5\text{V}, I_D = -8\text{A}$	-	36	-	S
Dynamic Characteristics⁵						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$	-	1630	-	pF
Output Capacitance	C_{oss}		-	211	-	
Reverse Transfer Capacitance	C_{rss}		-	187	-	
Gate Resistance	R_g	$f = 1\text{MHz}$	-	10	-	Ω
Switching Characteristics⁵						
Total Gate Charge	Q_g	$V_{\text{GS}} = -4.5\text{V}, V_{\text{DS}} = -10\text{V}, I_D = -8\text{A}$	-	12	-	nC
Gate-Source Charge	Q_{gs}		-	1.8	-	
Gate-Drain Charge	Q_{gd}		-	3.2	-	
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, V_{\text{DD}} = -10\text{V}, R_G = 3\Omega, I_D = -8\text{A}$	-	17	-	ns
Rise Time	t_r		-	25.5	-	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	32	-	
Fall Time	t_f		-	15	-	
Drain-Source Body Diode Characteristics						
Diode Forward Voltage ⁴	V_{SD}	$I_S = -8\text{A}, V_{\text{GS}} = 0\text{V}$	-	-	-1.2	V
Continuous Source Current $T_A = 25^\circ\text{C}$	I_S	-	-	-	-40	A

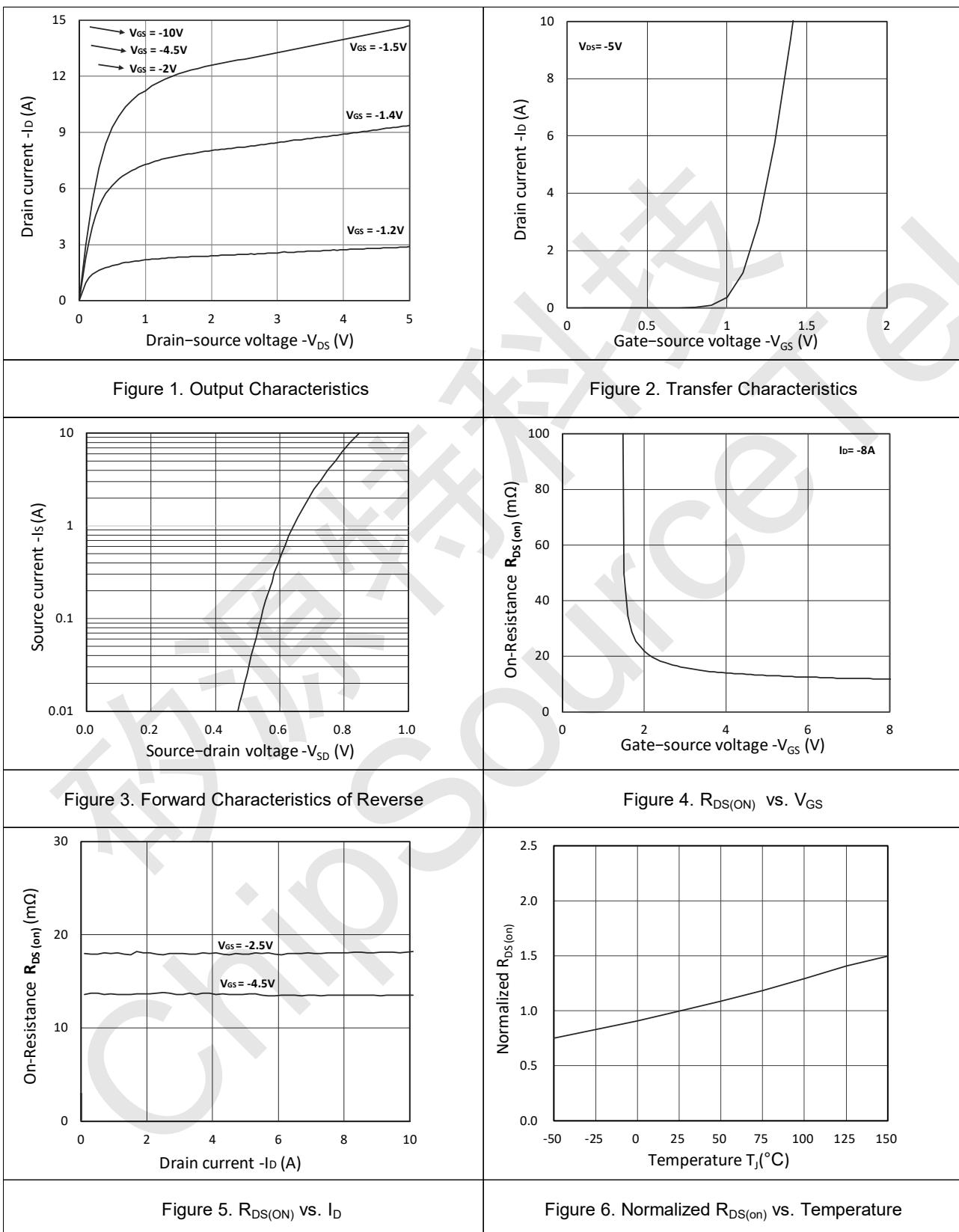
Notes:

- Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{C}$.
- The EAS data shows Max. rating . The test condition is $V_{\text{DD}}= -25\text{V}, V_{\text{GS}}= -10\text{V}, L= 0.1\text{mH}, I_{\text{AS}}= -24\text{A}$
- The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- The data tested by pulsed , pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
- This value is guaranteed by design hence it is not included in the production test..



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CST20P09L Typical Characteristics





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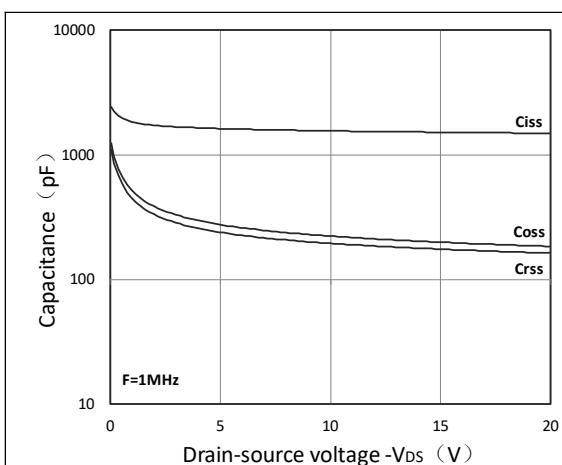


Figure 7. Capacitance Characteristics

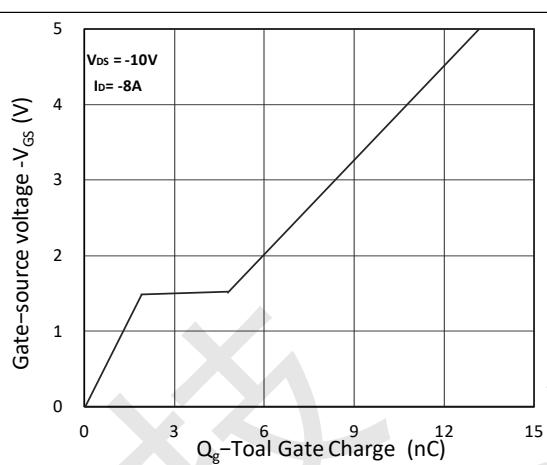


Figure 8. Gate Charge Characteristics

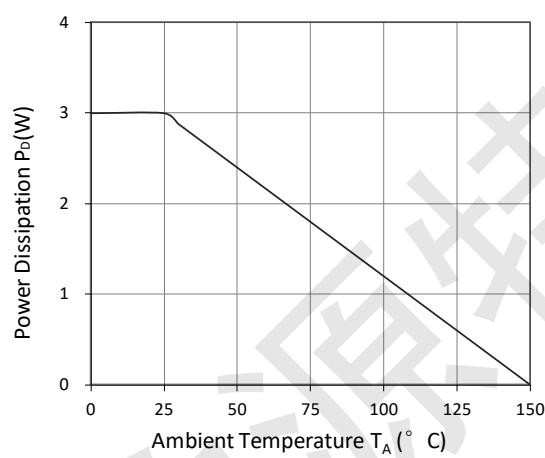


Figure 9. Power Dissipation

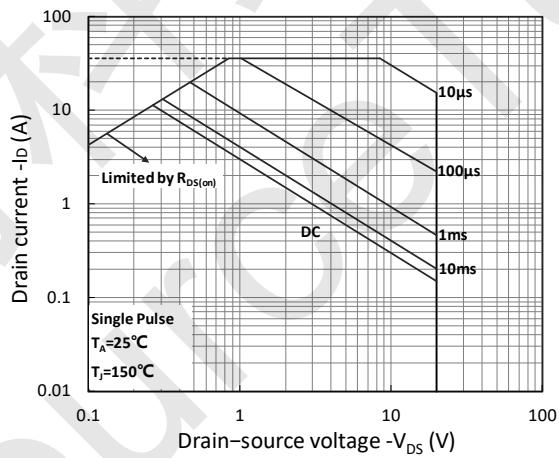


Figure 10. Safe Operating Area

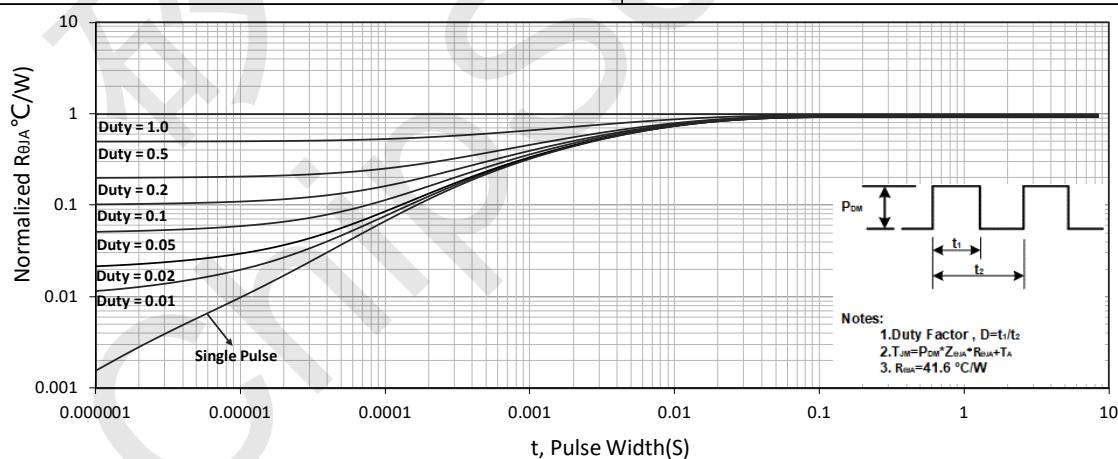


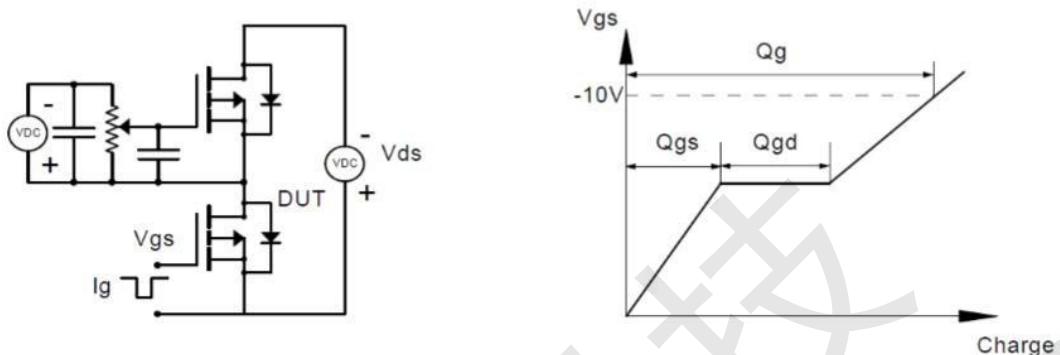
Figure 11. Normalized Maximum Transient Thermal Impedance



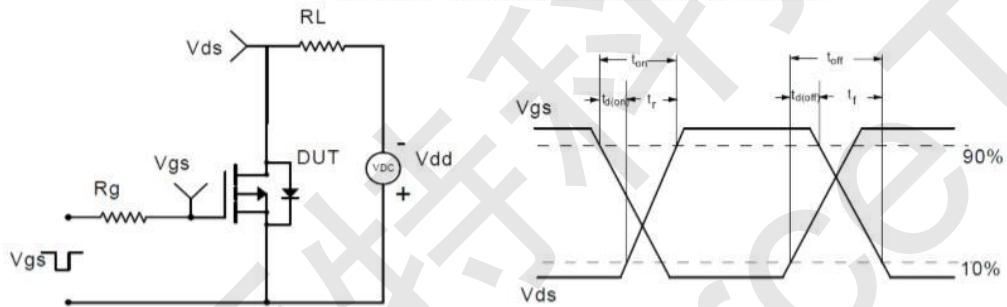
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CST20P09L Test Circuit

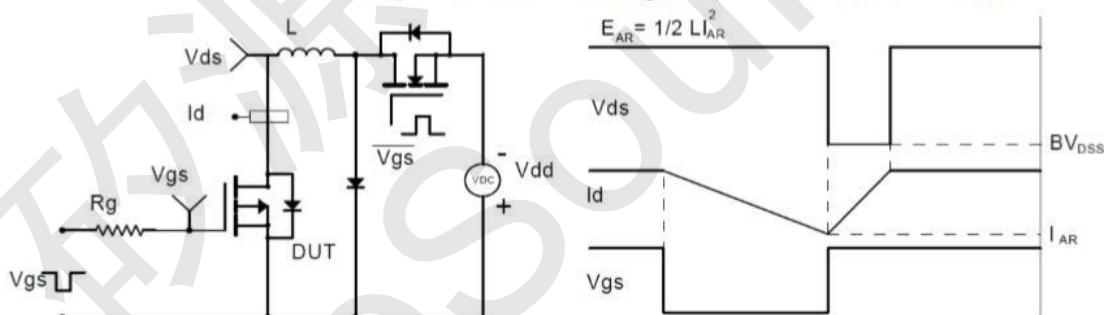
Gate Charge Test Circuit & Waveform



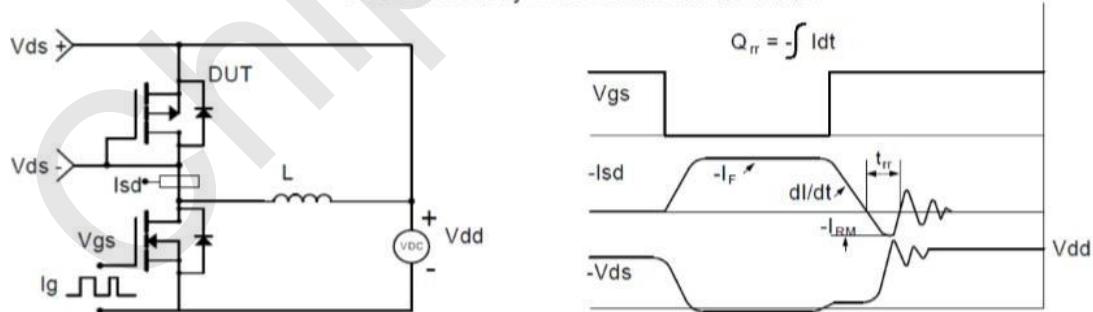
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



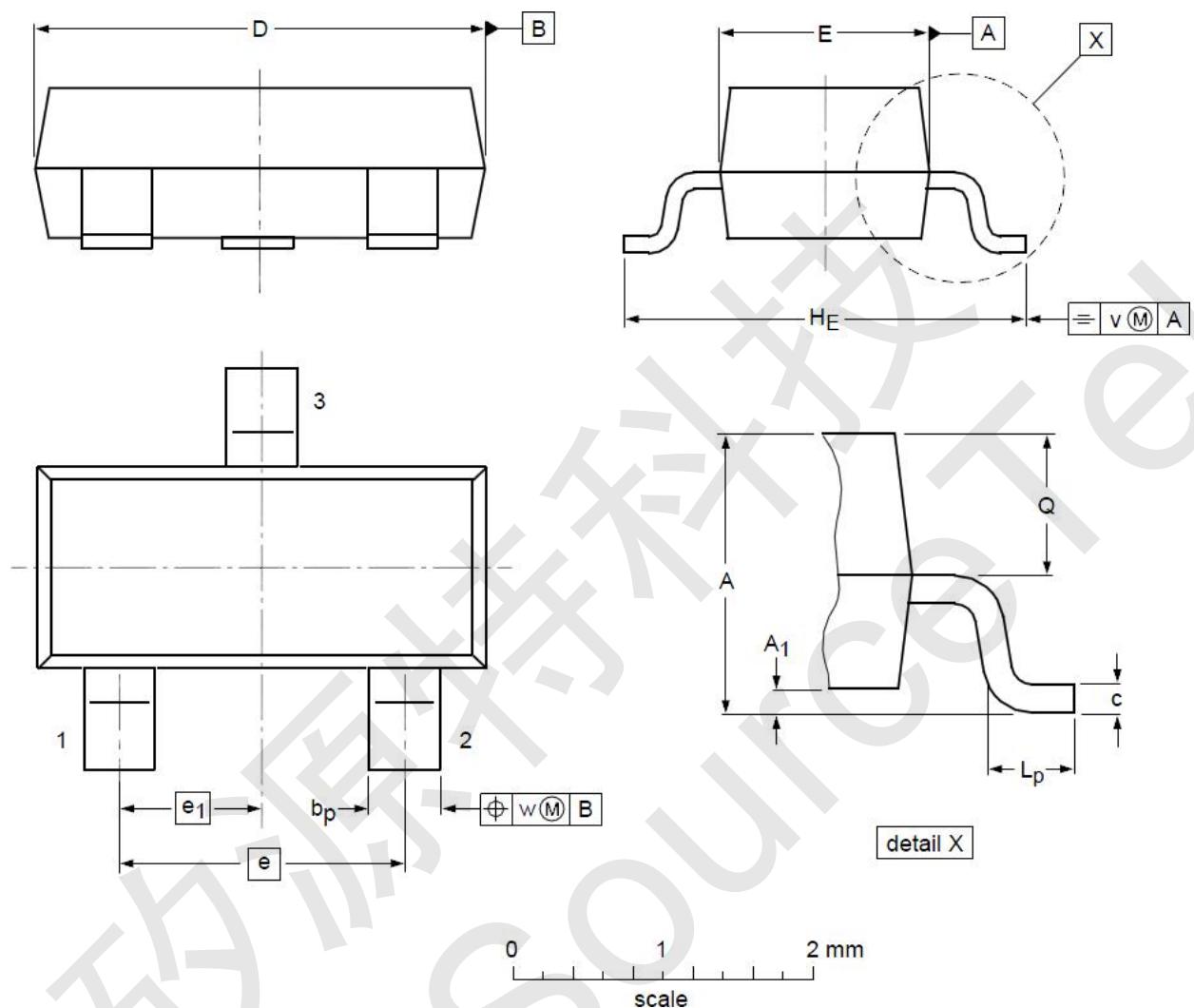
Diode Recovery Test Circuit & Waveforms





CST20P09L P-Ch 20V Fast Switching MOSFETs

CST20P09L Package Mechanical Data-SOT-23-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°